

BFR520 NPN 9 GHz wideband transistor Rev. 4 — 13 September 2011

Product data sheet

1. Product profile

1.1 General description

The BFR520 is an NPN silicon planar epitaxial transistor in a SOT23 plastic package.

1.2 Features and benefits

- High power gain
- Low noise figure
- High transition frequency
- Gold metallization ensures excellent reliability.

1.3 Applications

- RF front end wideband applications in the GHz range
 - Analog and digital cellular telephones
 - Cordless telephones (CT1, CT2, DECT, etc.)
 - Radar detectors
 - Pagers and satellite TV tuners (SATV)
 - Repeater amplifiers in fiber-optic systems.

1.4 Quick reference data

Table 1. Quick reference data

Symbol	Parameter	Conditions		Min	Тур	Max	Unit
V _{CBO}	collector-base voltage			-	-	20	V
V _{CES}	collector-emitter voltage	R _{BE} = 0 Ω		-	-	15	V
I _C	collector current (DC)			-	-	70	mA
P _{tot}	total power dissipation	up to T_{sp} = 97 °C	[1]	-	-	300	mW
h _{FE}	DC current gain	$I_{C} = 20 \text{ mA}; V_{CE} = 6 \text{ V}$		60	120	250	
C _{re}	feedback capacitance	$I_{C} = i_{c} = 0 \text{ A}; V_{CB} = 6 \text{ V};$ f = 1 MHz		-	0.4	-	pF
f _T	transition frequency	$I_C = 20 \text{ mA}; V_{CE} = 6 \text{ V};$ f = 1 GHz		-	9	-	GHz
G _{UM}	maximum unilateral power gain	$ I_C = 20 \text{ mA}; V_{CE} = 6 \text{ V}; $					
		f = 900 MHz		-	15	-	dB
		f = 2 GHz		-	9	-	dB



NPN 9	GHz v	videband	transistor
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Table 1.	Quick reference datacontinued					
Symbol	Parameter	Conditions	Min	Тур	Мах	Unit
s ₂₁ ²	insertion power gain	$ I_{C} = 20 \text{ mA}; V_{CE} = 6 \text{ V}; $	13	14	-	dB
NF	noise figure	$\Gamma_{s} = \Gamma_{opt}; T_{amb} = 25 \ ^{\circ}C$				
	I _C = 5 mA; V _{CE} = 6 V; f = 900 MHz	-	1.1	1.6	dB	
		$I_{C} = 20 \text{ mA}; V_{CE} = 6 \text{ V};$ f = 900 MHz	-	1.6	2.1	dB
		I _C = 5 mA; V _{CE} = 8 V; f = 2 GHz	-	1.9	-	dB

 Table 1.
 Quick reference data ...continued

[1] T_{sp} is the temperature at the soldering point of the collector tab.

2. Pinning information

Pin	Description	Simplified outline	Symbol
1	base		_
2	emitter		3
3	collector	1 2	

3. Ordering information

Table 3. Ordering information					
Type number Package					
	Name	Description	Version		
BFR520	-	plastic surface mounted package; 3 leads	SOT23		

4. Marking

Table 4. Marking	
Type number	Marking code ^[1]
BFR520	32*

[1] * = p: Made in Hong Kong

- * = t: Made in Malaysia
- * = W: Made in China.

sym021

5. Limiting values

Table 5.Limiting valuesIn accordance with the Absolute Maximum Rating System (IEC 60134).							
Symbol	Parameter	Conditions	Min	Max	Unit		
V _{CBO}	collector-base voltage	open emitter	-	20	V		
V _{CES}	collector-emitter voltage	$R_{BE} = 0 \Omega$	-	15	V		
V _{EBO}	emitter-base voltage	open collector	-	2.5	V		
l _C	collector current (DC)		-	70	mA		
P _{tot}	total power dissipation	up to $T_{sp} = 97 \ ^{\circ}C$	<u>[1]</u> _	300	mW		
T _{stg}	storage temperature		-65	150	°C		
Tj	junction temperature		-	175	°C		

[1] T_{sp} is the temperature at the soldering point of the collector tab.

6. Thermal characteristics

	Table 6.	Thermal characterist	tics
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Symbol	Parameter	Conditions	Тур	Unit
R _{th(j-s)}	thermal resistance from junction to soldering point		<u>[1]</u> 260	K/W

[1] T_{sp} is the temperature at the soldering point of the collector tab.

7. Characteristics

Table 7. **Characteristics** $T_i = 25 \ ^{\circ}C$ unless otherwise specified. Conditions Symbol Parameter Min Max Тур collector cut-off $I_E = 0 A$; $V_{CB} = 6 V$ I_{CBO} 50 current h_{FE} DC current gain $I_C = 20 \text{ mA}; V_{CE} = 6 \text{ V}$ 60 120 250 $I_{C} = i_{c} = 0 A; V_{EB} = 0.5 V;$ emitter Ce -1 f = 1 MHzcapacitance C_{c} $I_E = i_e = 0 A; V_{CB} = 6 V;$ collector -0.5 capacitance f = 1 MHzC_{re} feedback $I_{C} = 0 A; V_{CB} = 6 V;$ 0.4 -_ capacitance f = 1 MHzf_T $I_{C} = 20 \text{ mA}; V_{CE} = 6 \text{ V};$ 9 transition -f = 1 GHzfrequency $I_{C} = 20 \text{ mA}; V_{CE} = 6 \text{ V};$ [1] G_{UM} maximum unilateral power T_{amb} = 25 °C gain f = 900 MHz 15 -f = 2 GHz9 --|s₂₁|² 13 14 -

 $|s_{21}|^2$ insertion power $I_C = 20 \text{ mA}; V_{CE} = 6 \text{ V};$ gain $T_{amb} = 25 \text{ °C}; f = 900 \text{ MHz}$

BFR520

Unit

nA

pF

pF

рF

GHz

dB

dB

dB

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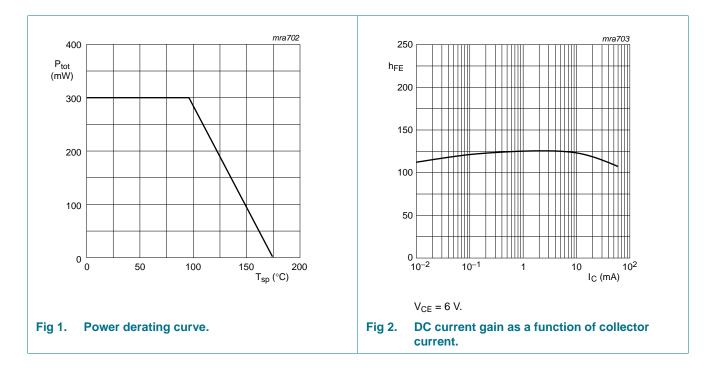
Table 7. $T_j = 25 ^{\circ}C$	Characteristic Cunless otherwise					
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
NF	noise figure	$\Gamma_{s} = \Gamma_{opt}; V_{CE} = 6 V;$ $T_{amb} = 25 \text{ °C}$				
		l _C = 5 mA; f = 900 MHz	-	1.1	1.6	dB
		I _C = 20 mA; f = 900 MHz	-	1.6	2.1	dB
		I _C = 5 mA; f = 2 GHz	-	1.9	-	dB
P _{L(1dB)}	output power at 1 dB gain compression	$ I_{C} = 20 \text{ mA}; V_{CE} = 6 \text{ V}; R_{L} = 50 \Omega; T_{amb} = 25 \text{ °C}; f = 900 \text{ MHz} $	-	17	-	dBm
ITO	third order intercept point		[2] _	26	-	dBm

Tab	le 7.	Characteristics	continued
T	25.00	unless stheswices	and alfied

[1] G_{UM} is the maximum unilateral power gain, assuming s₁₂ is zero and

$$G_{UM} = 10 \log \frac{|s_{21}|^2}{(1 - |s_{11}|^2)(1 - |s_{22}|^2)} dB.$$

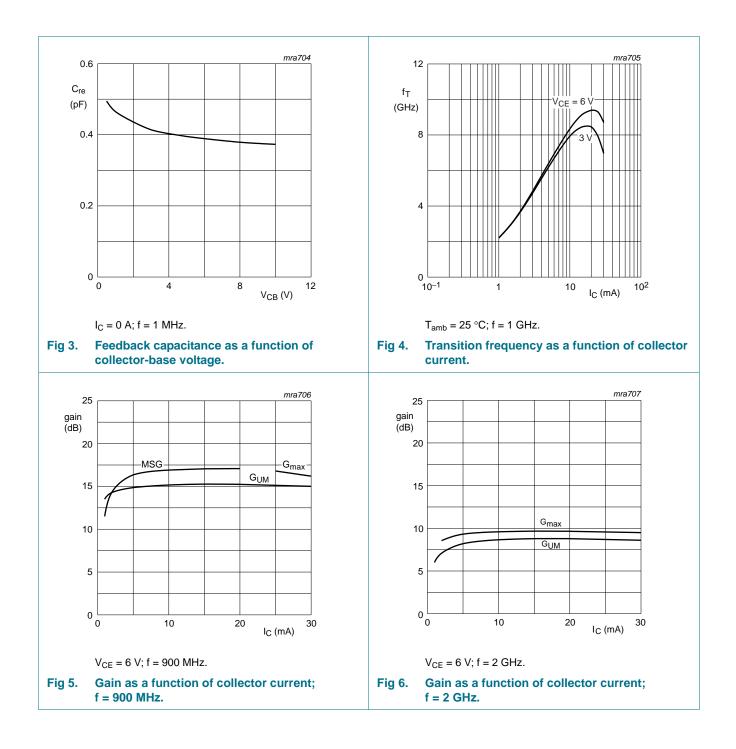
[2] $I_C = 20 \text{ mA}; V_{CE} = 6 \text{ V}; R_L = 50 \Omega; T_{amb} = 25 \text{ °C}; f_p = 900 \text{ MHz}; f_q = 902 \text{ MHz}$ Measured at $f_{(2p-q)}$ = 898 MHz and $f_{(2q-p)}$ = 904 MHz.



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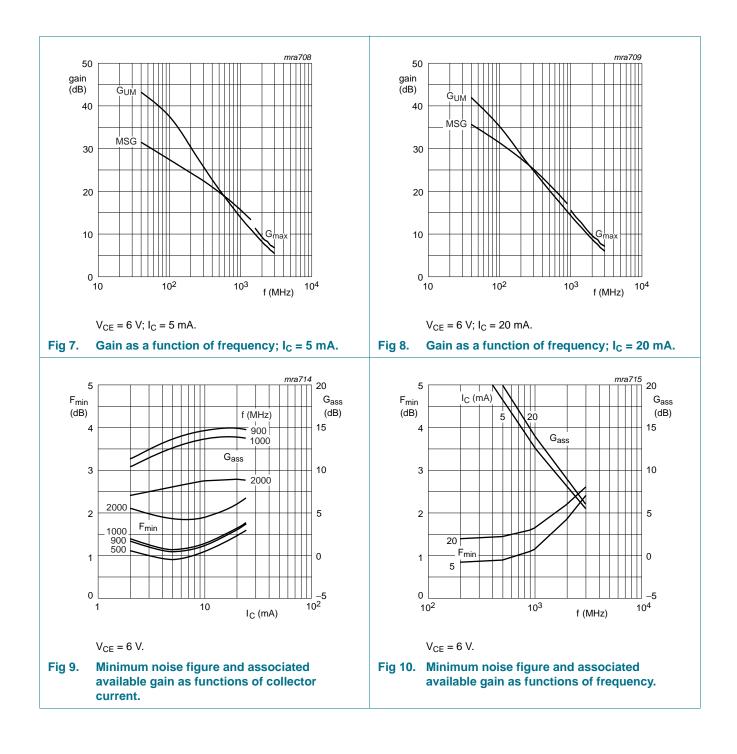
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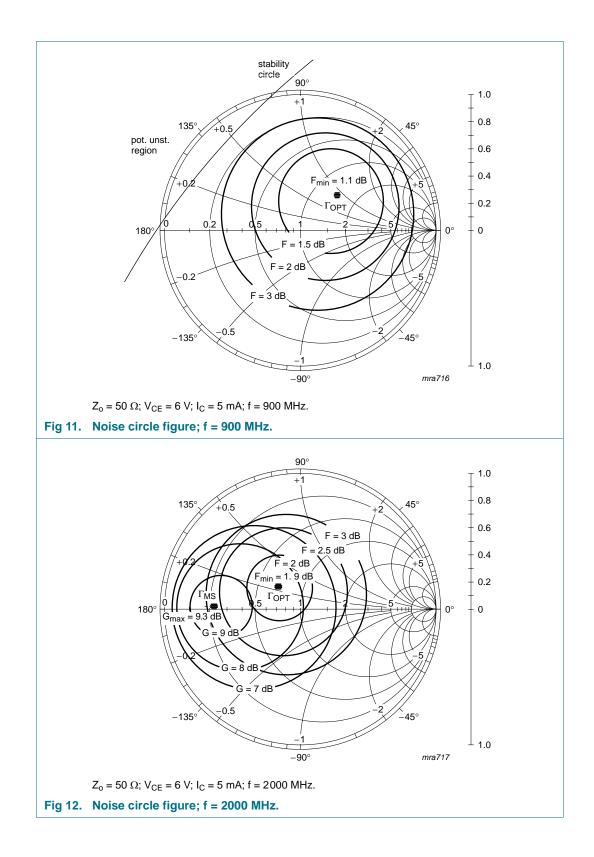
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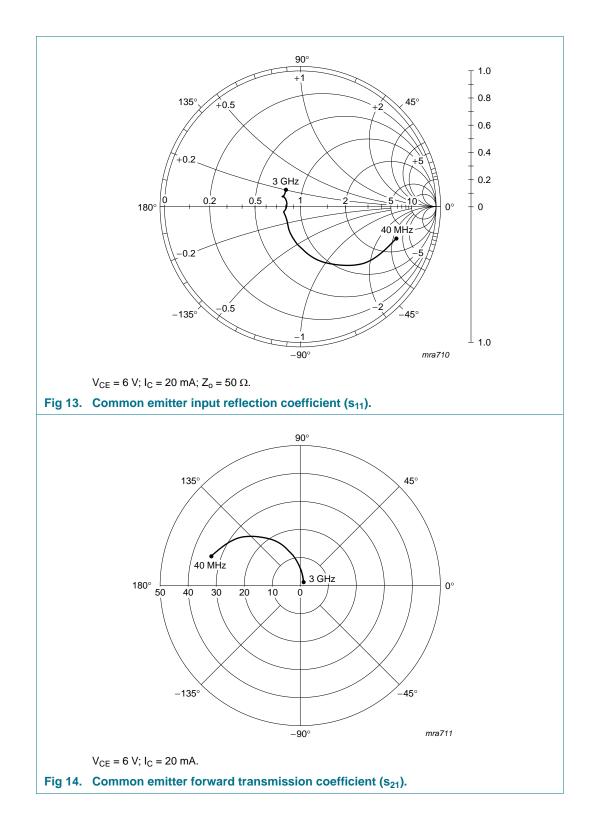
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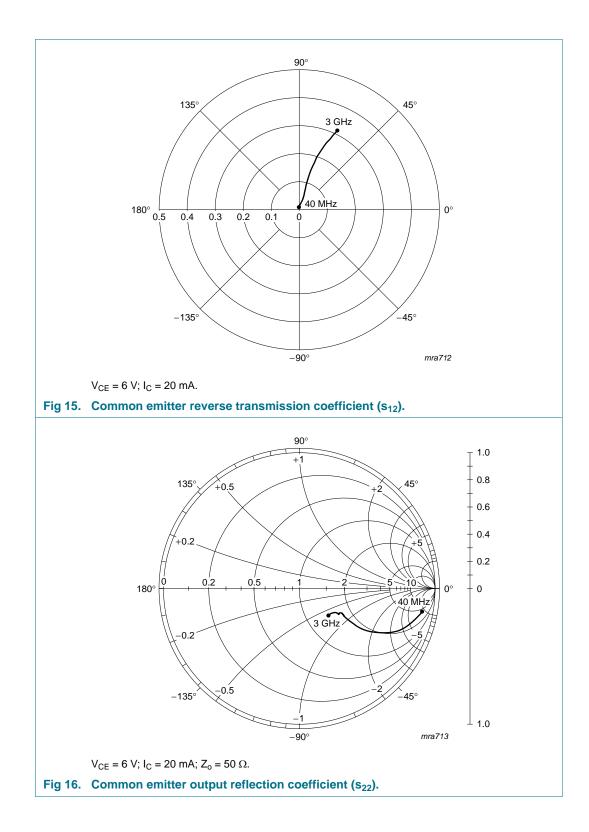
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8. Package outline

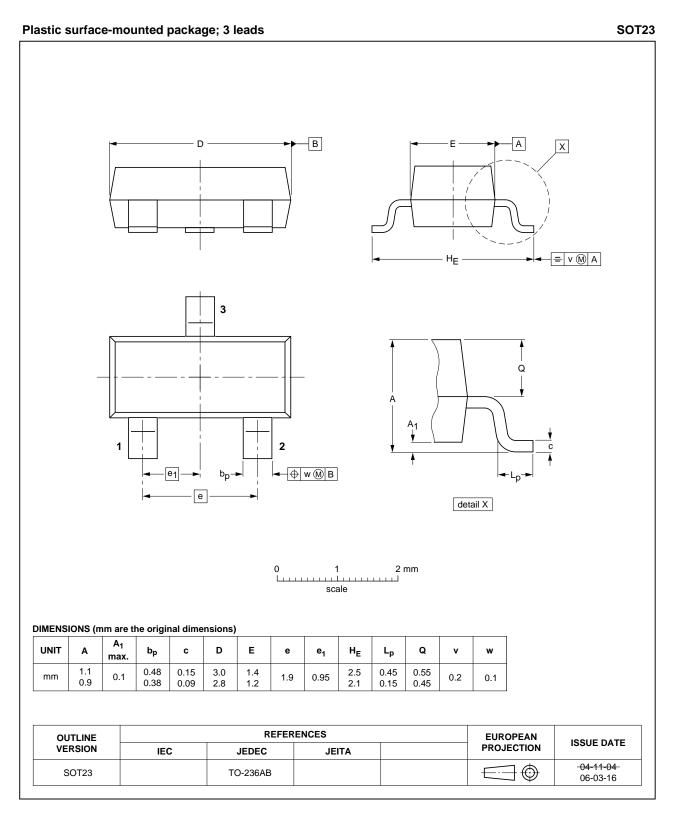


Fig 17. Package outline SOT23 (TO-236AB).

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9. Revision history

ory			
Release date	Data sheet status	Change notice	Supersedes
20110913	Product data sheet	-	BFR520 v.3
		esigned to comply w	ith the new identity
 Legal texts have 	ave been adapted to the new	company name whe	re appropriate.
 Package outling 	line drawings have been upda	ted to the latest vers	ion.
20040901	Product data sheet	-	BFR520_CNV v.2
19971204	Product specification	-	-
	Release date 20110913 • The format or guidelines of • Legal texts h • Package out 20040901	Release date Data sheet status 20110913 Product data sheet • The format of this data sheet has been reduguidelines of NXP Semiconductors. • Legal texts have been adapted to the new of Package outline drawings have been update 20040901 Product data sheet	Release date Data sheet status Change notice 20110913 Product data sheet - • The format of this data sheet has been redesigned to comply w guidelines of NXP Semiconductors. - • Legal texts have been adapted to the new company name when • • Package outline drawings have been updated to the latest version - 20040901 Product data sheet -

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10.1 Data sheet status

Document status[1][2]	Product status ^[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

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[2] The term 'short data sheet' is explained in section "Definitions".

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